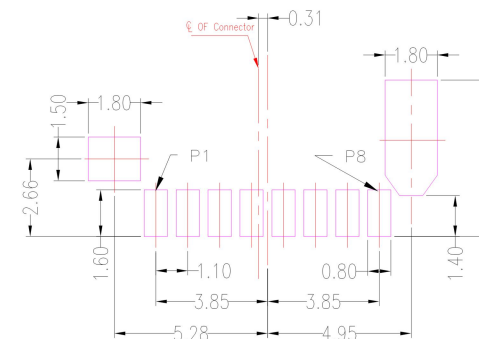
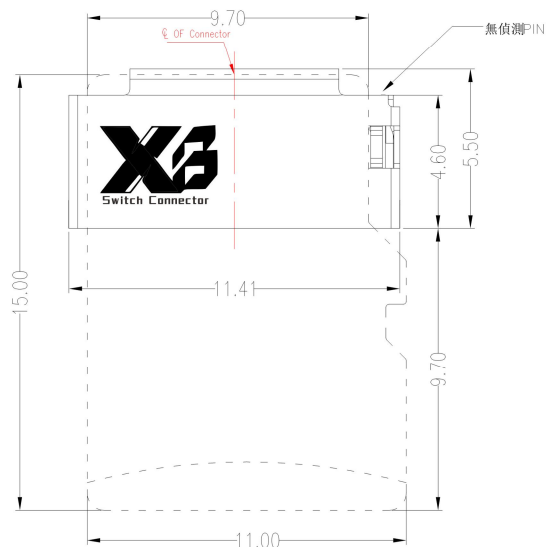
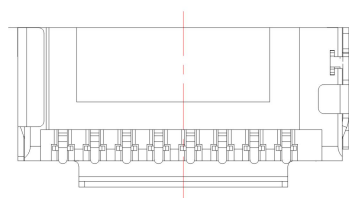
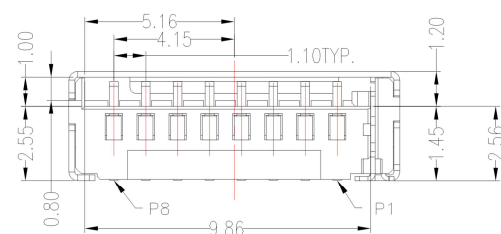




PCB LAYOUT



Pin No.	NAME
1	DAT2
2	CD/DAT3
3	CMD
4	VDD
5	CLK
6	VSS
7	DAT0
8	DAT1

SPECIFICATION

Electrical :

- 1.Contact Resistance: 50 m Ω Max.
- 2.Insulation Resistance: 1000 M Ω Min.
- 3.Dielectric Withstanding Voltage: 500V RMS.
- 4.Life Cycles: 1500 cycles Min
- 5.Mate Force: 4.5kgf Max
- 6.Unmate Force: 0.5kgf Min

Environmental:

- 1.Operating Temperature: -25°C ~ +85°C.

Material:

- 1.Housing: LCP,Black
- 2.Contact: Copper Alloy
- 3.Shell: SPCC

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer



东莞市溪榜电子有限公司
DONG GUAN XI BANG ELECTRONICS CO., LTD.

TOLERANCE UNLESS OTHERWISE STATED :
Up to 5 ± 0.2
Above 5 ~ 15 ± 0.3
Above 15 ~ 30 ± 0.4
Above 30 ~ 50 ± 0.5
Angle $\pm 0.3^\circ$

3RD.
ANGEL'S



UNITS

MM

DRAWN BY:	DATE	MAT'L		TITLE	CONNECTOR
Jack Lu	07/13/20	FINISH		MODLE	MICRO SD 卡 短體不帶偵測PIN
CHECKED BY:	DATE	SCALE	1 : 1	DWG NO.	SD-TF03-1108A2-S304
Jacky Chen	07/13/20	SHEET NO.	1 of 1	PART NO.	SD-TF03-1108A2-S304
APPROVED BY:	DATE				
Tony Kao	07/13/20				

1	更新高度選項	Jack	071320
ITEM NO.	DESCRIPTION	DRAWN	DATE